

# CRST030N10N,CRSS028N10N

SkyMOS1 N-MOSFET 100V,  $2.5m\Omega$ , 180A

#### **Features**

- Uses CRM(CQ) advanced SkyMOS1 technology
- Extremely low on-resistance R<sub>DS(on)</sub>
- Excellent Q<sub>q</sub>xR<sub>DS(on)</sub> product(FOM)
- Qualified according to JEDEC criteria

# Product Summary

$V_{DS}$	100V
R <sub>DS(on)</sub>	$2.5 m\Omega$
$I_{D}$	180A

## **Applications**

- Synchronous Rectification for AC/DC Quick Charger
- Battery management
- UPS (Uninterrupible Power Supplies)

100% Avalanche Tested



#### **Package Marking and Ordering Information**

Part #	Marking	Package	Packing	Reel Size	Tape Width	Qty
CRST030N10N	-	TO-220	Tube	N/A	N/A	50pcs
CRSS028N10N	-	TO-263	Tube	N/A	N/A	50pcs

#### **Absolute Maximum Ratings**

Parameter	Symbol	Value	Unit
Drain-source voltage	$V_{DS}$	100	V
Continuous drain current			
T <sub>C</sub> = 25°C (Silicon limit)	, t	207	Α
T <sub>C</sub> = 25°C (Package limit)	$I_{D}$	180	
T <sub>C</sub> = 100°C (Silicon limit)		131	
Pulsed drain current ( $T_C = 25$ °C, $t_p$ limited by $T_{jmax}$ )	${ m I_{D~pulse}}$	720	Α
Avalanche energy, single pulse (L=0.5mH, Rg=25 $\Omega$ ) <sup>[1]</sup>	E <sub>AS</sub>	529	mJ
Gate-Source voltage	$V_{GS}$	±20	V
Power dissipation ( $T_C = 25^{\circ}C$ )	P <sub>tot</sub>	227	W
Operating junction and storage temperature	$T_j$ , $T_{stg}$	-55+150	°C

Notes:1.EAS was tested at  $Tj = 25^{\circ}C$ , ID = 46A.





# CRST030N10N,CRSS028N10N

SkyMOS1 N-MOSFET 100V,  $2.5m\Omega$ , 180A

## **Thermal Resistance**

Parameter	Symbol	Max	Unit
Thermal resistance, junction – case.	$R_{thJC}$	0.55	°C/W
Thermal resistance, junction – ambient(min. footprint)	$R_{thJA}$	62	- C/ VV

# **Electrical Characteristic** (at Tj = 25 °C, unless otherwise specified)

Davameter	Symbol	Value			Unit	Test Condition	
Parameter	Symbol	min.	typ.	max.	Unit	rest Condition	
Static Characteristic							
Drain-source breakdown voltage	BV <sub>DSS</sub>	100	-	-	V	V <sub>GS</sub> =0V, I <sub>D</sub> =250uA	
Gate threshold voltage	V <sub>GS(th)</sub>	2.2	3	3.8	V	$V_{DS}=V_{GS}$ , $I_{D}=250$ uA	
						V <sub>DS</sub> =100V,V <sub>GS</sub> =0V	
Zero gate voltage drain current	$I_{DSS}$	-	0.05	1	μΑ	T <sub>j</sub> =25°C	
carrent		-	-	10		T <sub>j</sub> =125°C	
Gate-source leakage current	$I_{GSS}$	-	±10	±100	nA	$V_{GS}=\pm20V, V_{DS}=0V$	
						$V_{GS}=10V$ , $I_D=90A$	
Drain-source on-state resistance	R <sub>DS(on)</sub>	-	2.5	3.0		TO-220	
		-	2.3	2.8	mΩ	TO-263	
Transconductance	g <sub>fs</sub>	-	197.2	-	S	V <sub>DS</sub> =5V,I <sub>D</sub> =90A	

#### **Dynamic Characteristic**

Input Capacitance	C <sub>iss</sub>	-	11355	-		
Output Capacitance	C <sub>oss</sub>	-	1446	-	pF	$V_{GS}=0V$ , $V_{DS}=50V$ ,
Reverse Transfer Capacitance	C <sub>rss</sub>	-	54	-		f=1MHz
Gate Total Charge	$Q_{G}$	-	169	-		
Gate-Source charge	$Q_{gs}$	-	67	-	nC	$V_{GS}$ =10V, $V_{DS}$ =50V, $I_{D}$ =90A, f=1MHz
Gate-Drain charge	$Q_{gd}$	-	30	-		
Turn-on delay time	t <sub>d(on)</sub>	-	35	-		
Rise time	t <sub>r</sub>	-	111	-	nc	$V_{GS}=10V$ , $V_{DD}=50V$ , $R_{G\_ext}=3.0\Omega$
Turn-off delay time	t <sub>d(off)</sub>	-	84	-	ns	
Fall time	t <sub>f</sub>	-	112	-		
Gate resistance	$R_G$	-	1.8	-	Ω	$V_{GS}$ =0V, $V_{DS}$ =0V, f=1MHz





# CRST030N10N,CRSS028N10N

SkyMOS1 N-MOSFET 100V,  $2.5m\Omega$ , 180A

# **Body Diode Characteristic**

Parameter	Symbol		Value			Test Condition
	Syllibol	min.	typ.	max.	Unit	rest Condition
Body Diode Forward Voltage	$V_{SD}$	-	0.9	1.4	V	V <sub>GS</sub> =0V,I <sub>SD</sub> =90A
Body Diode Reverse Recovery Time	t <sub>rr</sub>	-	101	-	ns	I <sub>F</sub> =90A,
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	-	338	-	nC	I <sub>F</sub> =90A, dI/dt=100A/μs



### **Typical Performance Characteristics**

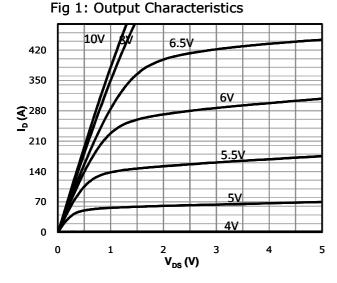
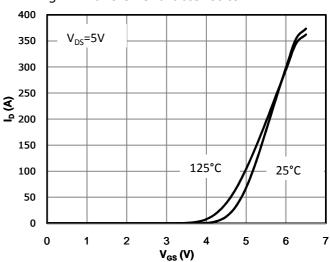


Fig 2: Transfer Characteristics



3: Rds(on) vs Drain Current and Gate Voltage 4.0  $V_{GS}=10V$ 3.0 R<sub>DS(on)</sub> (mΩ) 2.0 1.0 0.0 150 0 50 100 200  $I_D(A)$ 

Fig 4: Rds(on) vs Gate Voltage

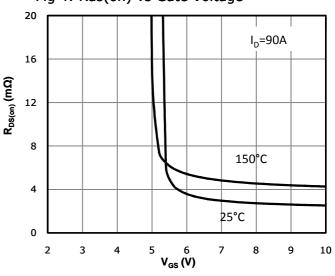


Fig 5: Rds(on) vs. Temperature

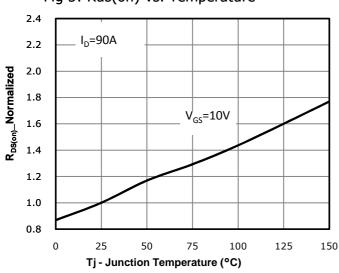
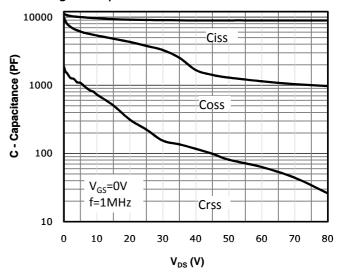


Fig 6: Capacitance Characteristics



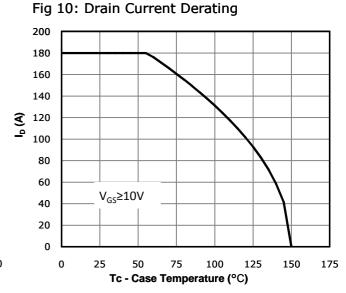


SkyMOS1 N-MOSFET 100V,  $2.5m\Omega$ , 180A

Fig 7: Gate Charge Characteristics 10  $V_{DS}=50V$ I<sub>D</sub>=90A 8 V<sub>GS</sub>(V) 6 4 2 0 0 30 60 120 150 180 Qg (nC)

Fig 8: Body-diode Forward Characteristics 100 I<sub>s</sub> - Diode Current(A) 10 125°C 25°C 1 0.1 0.01 0.2 0.8 1 0 0.4 0.6 1.2 V<sub>SD</sub> - Diode Forward Voltage(V)

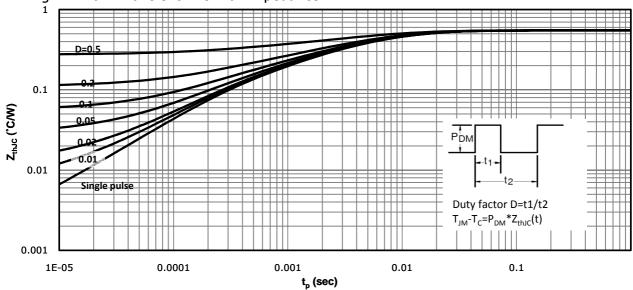
Fig 9: Power Dissipation 250 200 P<sub>tot</sub> (W) 150 100 50 0 0 25 50 75 100 125 150 Tc - Case Temperature (°C)





SkyMOS1 N-MOSFET 100V,  $2.5m\Omega$ , 180A

Fig 12: Max. Transient Thermal Impedance

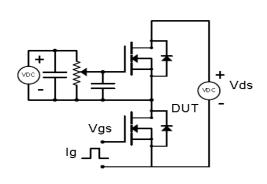


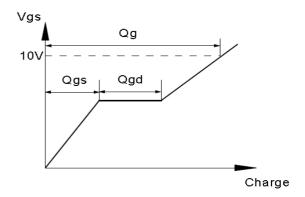


SkyMOS1 N-MOSFET 100V,  $2.5m\Omega$ , 180A

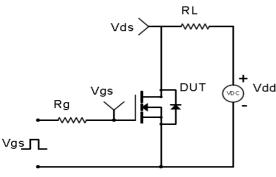
### **Test Circuit & Waveform**

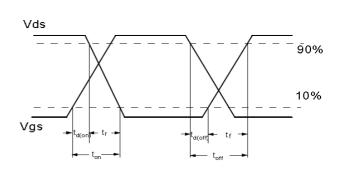
#### Gate Charge Test Circuit & Waveform



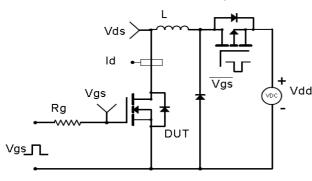


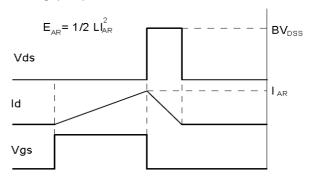
Resistive Switching Test Circuit & Waveforms



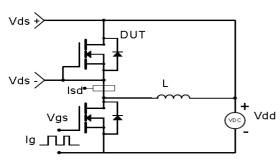


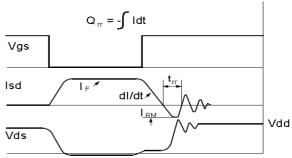
#### Unclamped Inductive Switching (UIS) Test Circuit & Waveforms





#### Diode Recovery Test Circuit & Waveforms

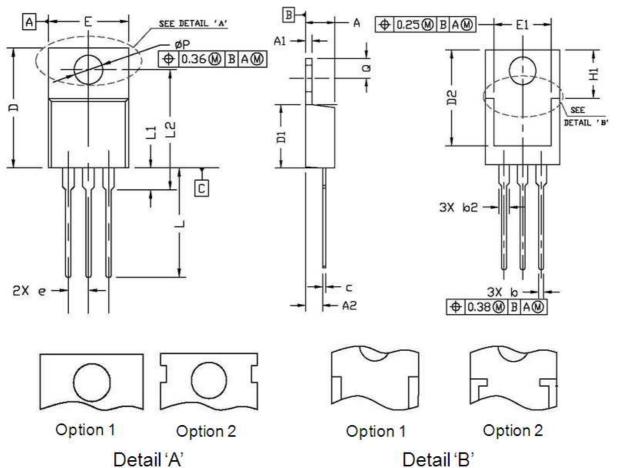






SkyMOS1 N-MOSFET 100V,  $2.5m\Omega$ , 180A

# Package Outline: TO-220-3L

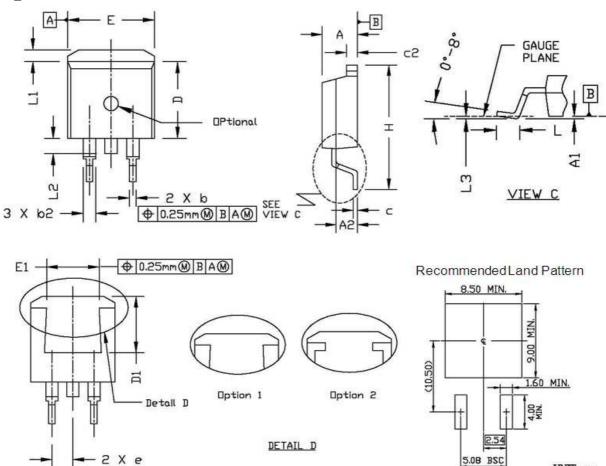


G	Dimensions In Millimeters		Dimensions	In Inches
Symbol	Min.	Max.	Min.	Max.
Α	4.30	4.80	0.169	0.189
A1	1.20	1.45	0.047	0.057
A2	2.20	2.90	0.087	0.114
b	0.69	0.95	0.027	0.037
b2	1.00	1.60	0.039	0.063
С	0.33	0.65	0.013	0.026
D	14.70	16.20	0.579	0.638
D1	8.59	9.65	0.338	0.380
D2	11.75	13.60	0.463	0.535
е	2.54	2.54 BSC.		BSC.
E	9.60	10.60	0.378	0.417
E1	7.00	8.46	0.276	0.333
H1	6.20	7.00	0.244	0.276
L	12.60	14.80	0.496	0.583
L1	2.70	3.80	0.106	0.150
L2	12.13	16.50	0.478	0.650
Q	2.40	3.10	0.094	0.122
Р	3.50	3.90	0.138	0.154



SkyMOS1 N-MOSFET 100V,  $2.5m\Omega$ , 180A

# Package Outline: TO-263



Symbol	Dimensions I	n Millimeters	Dimensions	s In Inches
Symbol	Min.	Max.	Min.	Max.
Α	4.30	4.86	0.169	0.191
A1	0.00	0.25	0.000	0.010
A2	2.34	2.79	0.092	0.110
b	0.68	0.94	0.027	0.037
b2	1.15	1.35	0.045	0.053
С	0.33	0.65	0.013	0.026
c2	1.17	1.40	0.046	0.055
D	8.38	9.45	0.330	0.372
D1	6.90	8.17	0.272	0.322
е	2.54	BSC.	0.100 BSC.	
E	9.78	10.50	0.385	0.413
E1	6.50	8.60	0.256	0.339
Н	14.61	15.88	0.575	0.625
L	2.24	3.00	0.088	0.118
L1	0.70	1.60	0.028	0.063
L2	1.00	1.78	0.039	0.070
L3	0.00	0.25	0.000	0.010



UNIT: mm



# CRST030N10N,CRSS028N10N

SkyMOS1 N-MOSFET 100V,  $2.5m\Omega$ , 180A

# **Revision History**

Revison	Date	Major changes
1.0	2018-09-28	Release of formal version.
2.0	2019-01-04	Add TO-263 package type information
3.0	2019-05-28	Supplement package outline info.

#### **Disclaimer**

Unless otherwise specified in the datasheet, the product is designed and qulified as a standard commercial product and is not intended for use in applications that require extraordinary levels of quality and reliability, such as automotive, aviation/aerospace and life-support devices or systems.

Any and all semicondutor products have certain probability to fail or malfunction, which may result in personal injury, death or property damage. Customer are solely responsible for providing adequate safe measures when design their systems.

CRM(CQ) reserves the right to improve product design, function and reliability without notice.

